Rev. 11 — 8 February 2024

Product data sheet

1. General description

The 74LVC00A is a quad 2-input NAND gate. Inputs can be driven from either 3.3 V or 5 V devices. This feature allows the use of these devices as translators in mixed 3.3 V and 5 V environments.

Schmitt-trigger action at all inputs makes the circuit tolerant of slower input rise and fall times.

2. Features and benefits

- · Overvoltage tolerant inputs to 5.5 V
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low-power consumption
- · Direct interface with TTL levels
- Complies with JEDEC standard:
 - JESD8-7A (1.65 V to 1.95 V)
 - JESD8-5A (2.3 V to 2.7 V)
 - JESD8-C/JESD36 (2.7 V to 3.6 V)
- · ESD protection:
 - HBM: ANSI/ESDA/JEDEC JS-001 class 2 exceeds 2000 V
 - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V
- · Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

3. Ordering information

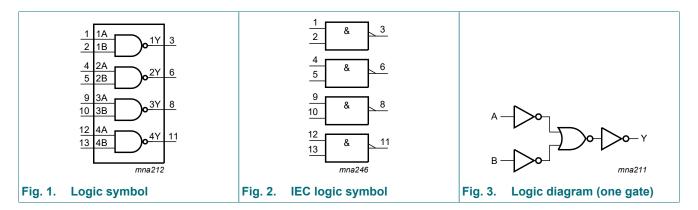
Table 1. Ordering information

Type number	Package						
	Temperature range	Name	Description	Version			
74LVC00AD	-40 °C to +125 °C	SO14	plastic small outline package; 14 leads; body width 3.9 mm	SOT108-1			
74LVC00APW	-40 °C to +125 °C	TSSOP14	plastic thin shrink small outline package; 14 leads; body width 4.4 mm	SOT402-1			
74LVC00ABQ	-40 °C to +125 °C	DHVQFN14	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 × 3 × 0.85 mm	SOT762-1			



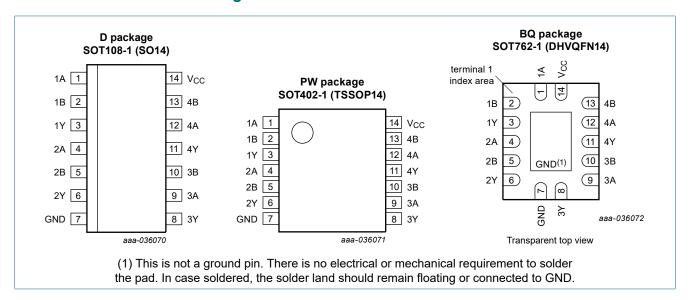
Quad 2-input NAND gate

4. Functional diagram



5. Pinning information

5.1. Pinning



5.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
1A to 4A	1, 4, 9, 12	data input
1B to 4B	2, 5, 10, 13	data input
1Y to 4Y	3, 6, 8,11	data output
GND	7	ground (0 V)
V _{CC}	14	supply voltage

Quad 2-input NAND gate

6. Functional description

Table 3. Function selection

 $H = HIGH \ voltage \ level; \ L = LOW \ voltage \ level; \ X = don't \ care$

Input	Output	
nA	nB	nY
L	X	Н
X	L	Н
Н	Н	L

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{CC}	supply voltage			-0.5	+6.5	V
I _{IK}	input clamping current	V _I < 0 V		-50	-	mA
VI	input voltage		[1]	-0.5	+6.5	V
I _{OK}	output clamping current	$V_O > V_{CC}$ or $V_O < 0 V$		-	±50	mA
Vo	output voltage	output in HIGH or LOW-state	[2]	-0.5	V _{CC} + 0.5	V
I _O	output current	$V_O = 0 V \text{ to } V_{CC}$		-	±50	mA
I _{CC}	supply current			-	100	mA
I _{GND}	ground current			-100	-	mA
P _{tot}	total power dissipation	T _{amb} = -40 °C to +125 °C	[3]	-	500	mW
T _{stg}	storage temperature			-65	+150	°C

^[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC}	supply voltage		1.65	-	3.6	V
		functional	1.2	-	-	V
V _I	input voltage		0	-	5.5	V
Vo	output voltage	output HIGH or LOW state	0	-	V _{CC}	V
T _{amb}	ambient temperature		-40	-	+125	°C
Δt/ΔV	input transition rise and fall rate	V _{CC} = 1.65 V to 2.7 V	0	-	20	ns/V
		V _{CC} = 2.7 V to 3.6 V	0	-	10	ns/V

^[2] The output voltage ratings may be exceeded if the output current ratings are observed.

^[3] For SOT108-1 (SO14) package: P_{tot} derates linearly with 10.1 mW/K above 100 °C. For SOT402-1 (TSSOP14) package: P_{tot} derates linearly with 7.3 mW/K above 81 °C. For SOT762-1 (DHVQFN14) package: P_{tot} derates linearly with 9.6 mW/K above 98 °C.

Quad 2-input NAND gate

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +85	5 °C	-40 °C to	+125 °C	Unit
			Min	Typ[1]	Max	Min	Max	
V _{IH}	HIGH-level	V _{CC} = 1.2 V	1.08	-	-	1.08	-	V
	input voltage	V _{CC} = 1.65 V to 1.95 V	0.65V _{CC}	-	-	0.65V _{CC}	-	V
		V _{CC} = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V
		V _{CC} = 2.7 V to 3.6 V	2.0	-	-	2.0	-	V
V _{IL}	LOW-level	V _{CC} = 1.2 V	-	-	0.12	-	0.12	V
	input voltage	V _{CC} = 1.65 V to 1.95 V	-	-	0.35V _{CC}	-	0.35V _{CC}	V
		V _{CC} = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V
		V _{CC} = 2.7 V to 3.6 V	-	-	0.8	-	0.8	V
V_{OH}	HIGH-level	V _I = V _{IH} or V _{IL}						
	output voltage	I _O = -100 μA; V _{CC} = 1.65 V to 3.6 V	V _{CC} - 0.2	-	-	V _{CC} - 0.3	-	V
		I _O = -4 mA; V _{CC} = 1.65 V	1.2	-	-	1.05	-	V
		I _O = -8 mA; V _{CC} = 2.3 V	1.8	-	-	1.65	-	V
		I _O = -12 mA; V _{CC} = 2.7 V	2.2	-	-	2.05	-	V
		I _O = -18 mA; V _{CC} = 3.0 V	2.4	-	-	2.25	-	V
		I _O = -24 mA; V _{CC} = 3.0 V	2.2	-	-	2.0	-	V
V _{OL}	LOW-level output voltage	V _I = V _{IH} or V _{IL}						
		I _O = 100 μA; V _{CC} = 1.65 V to 3.6 V	-	-	0.2	-	0.3	V
		I _O = 4 mA; V _{CC} = 1.65 V	-	-	0.45	-	0.65	V
		I _O = 8 mA; V _{CC} = 2.3 V	-	-	0.6	-	0.8	V
		I _O = 12 mA; V _{CC} = 2.7 V	-	-	0.4	-	0.6	V
		I _O = 24 mA; V _{CC} = 3.0 V	-	-	0.55	-	0.8	V
l _l	input leakage current	$V_{CC} = 3.6 \text{ V}; V_I = 5.5 \text{ V or GND}$	-	±0.1	±5	-	±20	μΑ
I _{CC}	supply current	$V_{CC} = 3.6 \text{ V}; V_I = V_{CC} \text{ or GND}; I_O = 0 \text{ A}$	-	0.1	10	-	40	μΑ
ΔI _{CC}	additional supply current	per input pin; $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V};$ $V_1 = V_{CC} - 0.6 \text{ V};$ $I_0 = 0 \text{ A}$	-	5	500	-	5000	μA
Cı	input capacitance	V_{CC} = 0 V to 3.6 V; V_{I} = GND to V_{CC}	-	4.0	-	-	-	pF

^[1] All typical values are measured at V_{CC} = 3.3 V (unless stated otherwise) and T_{amb} = 25 °C.

Quad 2-input NAND gate

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Fig. 5.

Symbol	Parameter	Conditions	-40	°C to +85	°C	-40 °C to	+125 °C	Unit
			Min	Typ[1]	Max	Min	Max	
t _{pd}	propagation delay	nA, nB to nY; see Fig. 4 [2]						
		V _{CC} = 1.2 V	-	12	-	-	-	ns
		V _{CC} = 1.65 V to 1.95 V	0.3	3.8	8.4	0.3	9.7	ns
		V _{CC} = 2.3 V to 2.7 V	1.0	2.2	4.8	1.0	5.7	ns
		V _{CC} = 2.7 V	1.0	2.3	5.1	1.0	5.9	ns
		V _{CC} = 3.0 V to 3.6 V	0.5	2.0	4.3	0.5	5.1	ns
t _{sk(o)}	output skew time	$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ [3]	-	-	1.0	-	1.5	ns
C _{PD}	power dissipation	per gate; $V_I = GND$ to V_{CC} [4]						
	capacitance	V _{CC} = 1.65 V to 1.95 V	-	5.6	-	-	-	pF
		V _{CC} = 2.3 V to 2.7 V	-	8.9	-	-	-	pF
		V _{CC} = 3.0 V to 3.6 V	-	11.8	-	-	-	pF

- [1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.2 V, 1.8 V, 2.5 V, 2.7 V, and 3.3 V respectively.
- [2] t_{pd} is the same as t_{PLH} and t_{PHL} .
- [3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.
- [4] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$ where:

f_i = input frequency in MHz; f_o = output frequency in MHz

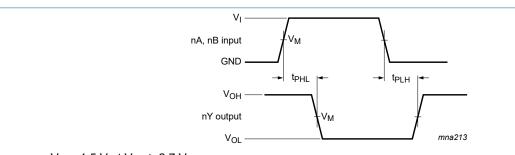
 C_L = output load capacitance in pF

V_{CC} = supply voltage in Volts

N = number of inputs switching

 $\Sigma(C_L \times V_{CC}^2 \times f_o) = \text{sum of the outputs}$

10.1. Waveforms and test circuit



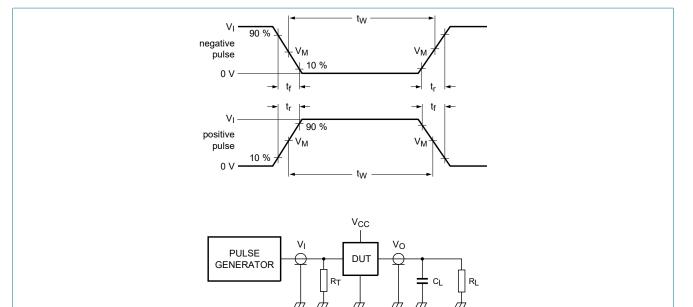
 $V_M = 1.5 \text{ V at } V_{CC} \ge 2.7 \text{ V}.$

 $V_M = 0.5 \times V_{CC}$ at $V_{CC} < 2.7 \text{ V}$.

V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig. 4. The input (nA, nB) to output (nY) propagation delays

Quad 2-input NAND gate



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Test data is given in <u>Table 8</u>. Definitions for test circuit:

R_L = Load resistance

C_L = Load capacitance including jig and probe capacitance

 R_{T} = Termination resistance should be equal to output impedance Z_{o} of the pulse generator

Fig. 5. Test circuit for measuring switching times

Table 8. Test data

Supply voltage	Input		Load		
	V _I	t _r , t _f	CL	R _L	
1.2 V	V _{CC}	≤ 2 ns	30 pF	1 kΩ	
1.65 V to 1.95 V	V _{CC}	≤ 2 ns	30 pF	1 kΩ	
2.3 V to 2.7 V	V _{CC}	≤ 2 ns	30 pF	500 Ω	
2.7 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	

Quad 2-input NAND gate

11. Package outline

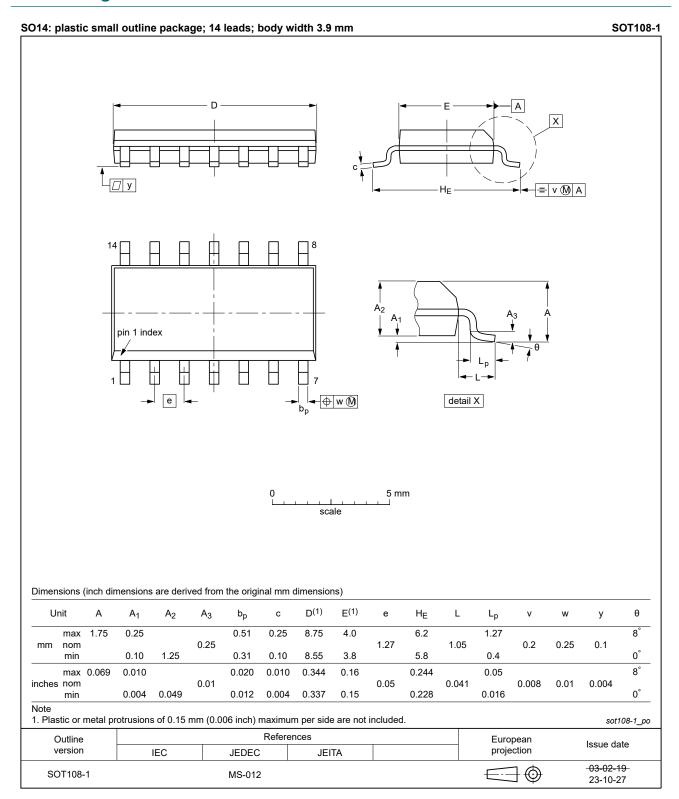


Fig. 6. Package outline SOT108-1 (SO14)

Quad 2-input NAND gate

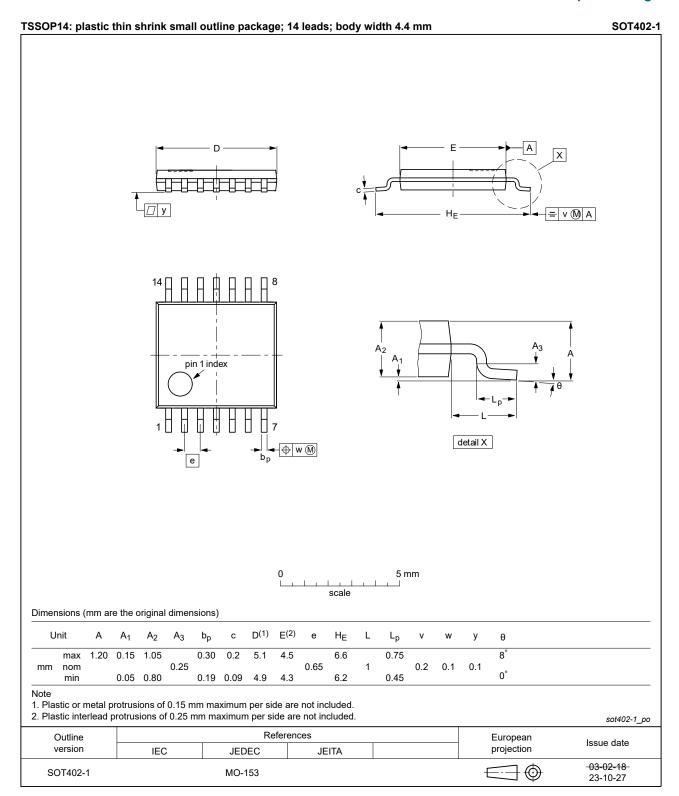


Fig. 7. Package outline SOT402-1 (TSSOP14)

Quad 2-input NAND gate

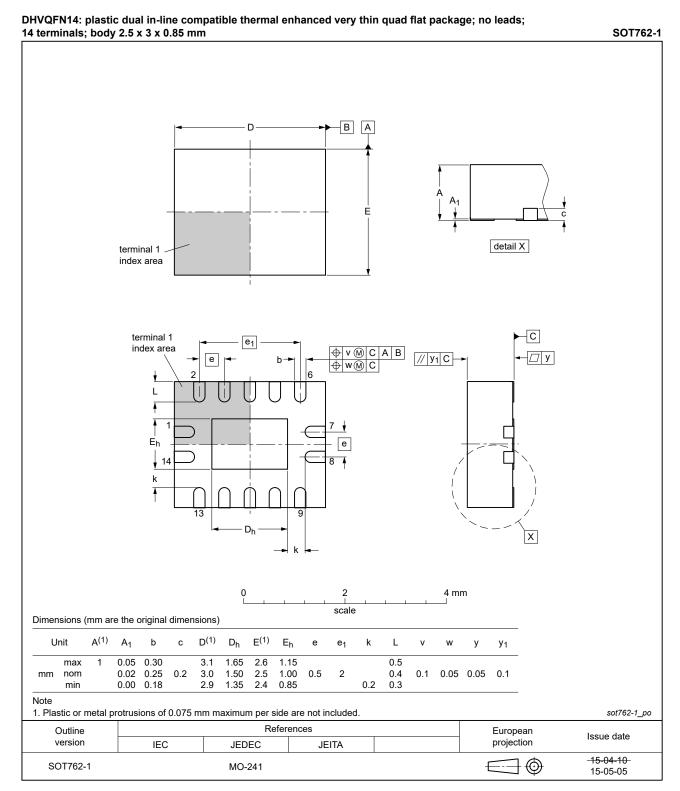


Fig. 8. Package outline SOT762-1 (DHVQFN14)

Quad 2-input NAND gate

12. Abbreviations

Table 9. Abbreviations

Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
TTL	Transistor-Transistor Logic

13. Revision history

Table 10. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes			
74LVC00A v.11	20240208	Product data sheet	-	74LVC00A v.10			
Modifications:	• <u>Fig. 6, Fig.</u> MO-153.	7: Aligned SO and TSSOP	package outline o	drawings to JEDEC MS-012 and			
74LVC00A v.10	20230801	Product data sheet	-	74LVC00A v.9			
Modifications:	Section 2: E	Section 2: ESD specification updated according to the latest JEDEC standard.					
74LVC00A v.9	20210917	Product data sheet	-	74LVC00A v.8			
Modifications:		Type Hamber 742 000/18B (00 1007 1/0001 14) Tellioved.					
74LVC00A v.8	20200824	Product data sheet	-	74LVC00A v.7			
Modifications:	guidelines of Legal texts Table 4: De	of this data sheet has been of Nexperia. have been adapted to the rating values for P _{tot} total putline drawing of SOT762-1	new company nar power dissipation h	ne where appropriate.			
74LVC00A v.7	20120425	Product data sheet	-	74LVC00A v.6			
Modifications:	• <u>Table 2</u> : Err	ata in pin description corre	cted.				
74LVC00A v.6	20120106	Product data sheet	-	74LVC00A v.5			
Modifications:	guidelines of NXP Ser • Legal texts	niconductors. have been adapted to the	new company nar	omply with the new identity me where appropriate. dded for lower voltage ranges.			
74LVC00A v.5	20030904	Product specification	-	74LVC00A v.4			
74LVC00A v.4	20030507	Product specification	-	74LVC00A v.3			
74LVC00A v.3	20020305	Product specification	-	74LVC00A v.2			
74LVC00A v.2	19980428	Product specification	-	74LVC00A v.1			
74LVC00A v.1	19970811	Product specification	-	-			

Product data sheet

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14. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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